

PS7200U-1A

4-PIN SOP LOW OFF-STATE LEAKAGE CURRENT 1-ch Optical Coupled MOS FET -NEPOC Series-

DESCRIPTION

The PS7200U-1A is a low output capacitance solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for high-frequency signal control, due to its extremely low off-state leakage current, low output capacitance, and high-speed turn-on time.

FEATURES

- Low off-state leakage current (ILoff = 0.1 nA TYP.)
- Break down voltage (V_L = 80 V)
- High-speed turn-on time (ton = 0.05 ms TYP.)
- Low output capacitance (Cout = 2.3 pF TYP.)
- $C \times R (C \times R = 40 pF \bullet \Omega)$
- 1 channel type (1 a output)
- · Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- · Low offset voltage
- Ordering number of taping product : PS7200U-1A-E3, E4: 900 pcs/reel

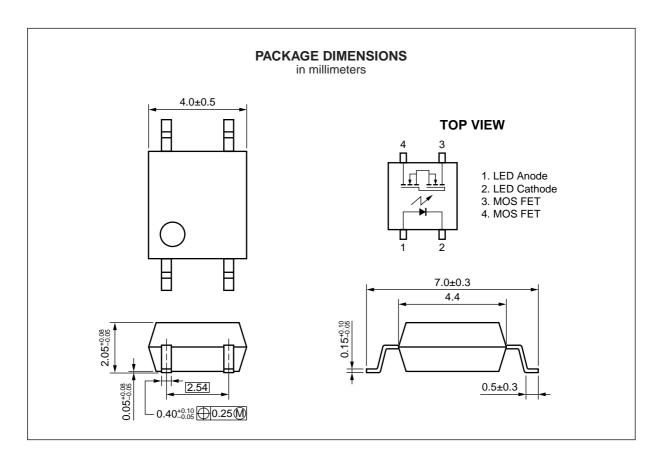
: PS7200U-1A-F3, F4: 3 500 pcs/reel

· Pb-Free product

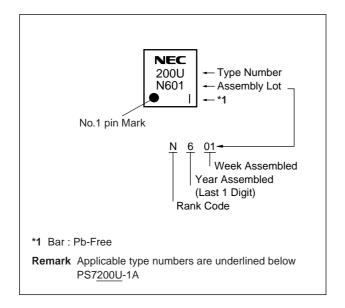
APPLICATIONS

· Measurement equipment

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<R> MARKING EXAMPLE (LASER MARKING)



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style
PS7200U-1A	PS7200U-1A-A	Pb-Free	Magazine case 100 pcs
PS7200U-1A-E3	PS7200U-1A-E3-A		Embossed Tape 900 pcs/reel
PS7200U-1A-E4	PS7200U-1A-E4-A		
PS7200U-1A-F3	PS7200U-1A-F3-A		Embossed Tape 3 500 pcs/reel
PS7200U-1A-F4	PS7200U-1A-F4-A		

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	50	mA	
	Reverse Voltage	VR	5.0	V	
	Power Dissipation	Po	50	mW	
	Peak Forward Current *1	I FP	1	Α	
MOS FET	Break Down Voltage	VL	80	V	
	Continuous Load Current	lι	40	mA	
	Pulse Load Current ² (AC/DC Connection)	ILP	80	mA	
	Power Dissipation	Po	300	mW	
Isolation Voltage *3		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	350	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} PW = 100 ms, 1 shot

^{*3} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

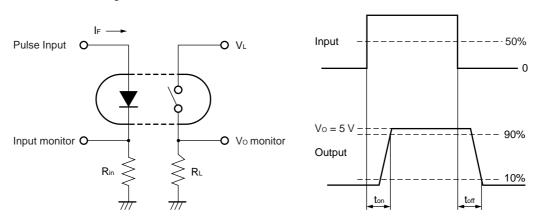
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

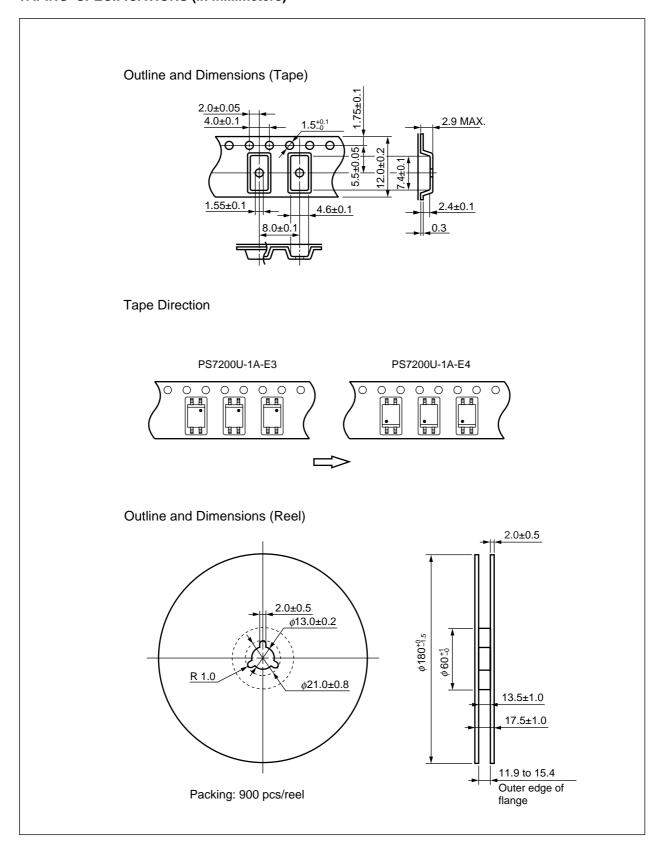
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.1	1.3	٧
	Reverse Current	lR	V _R = 5 V		0.01	5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V _D = 80 V		0.1	1.0	nA
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		2.3	3.5	pF
Coupled	LED On-state Current	IFon	I∟ = ±40 mA			2.0	mA
	On-state Resistance	Ron	$I_F = 5 \text{ mA}, I_L = \pm 40 \text{ mA}$		17	25	Ω
	Turn-on Time*1, 2	ton	IF = 5 mA, $V_L = 5 V$, $R_L = 500 \Omega$,		0.05	0.5	ms
	Turn-off Time*1, 2	t off	PW ≥ 0.5 ms		0.15	0.5	
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ⁹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.3		pF

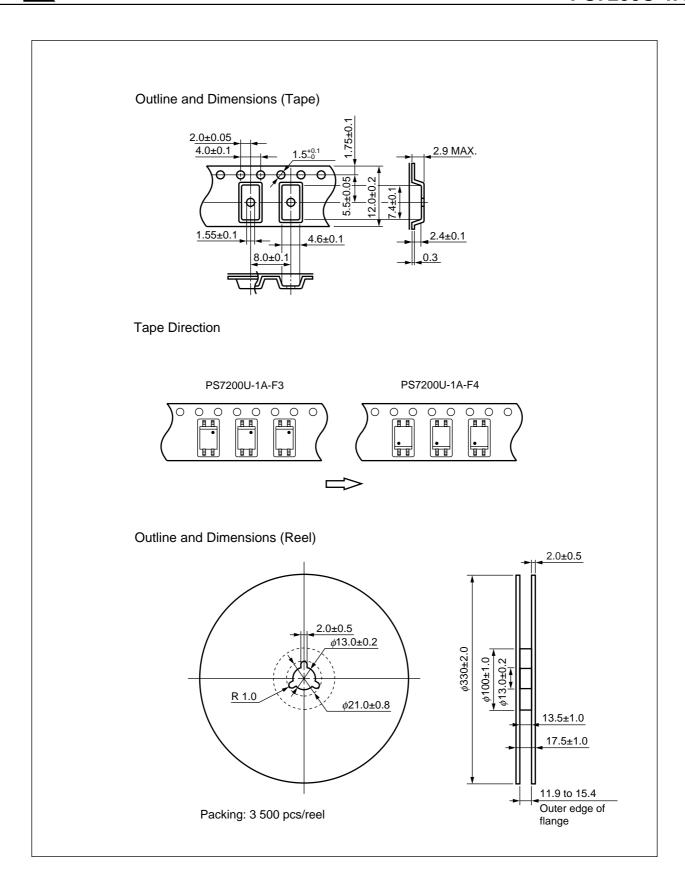
*1 Test Circuit for Switching Time



Be aware that when the device operates with an input-pulse width less than 0.5 ms, the turn-on time and turn-off time will increase.

TAPING SPECIFICATIONS (in millimeters)





RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

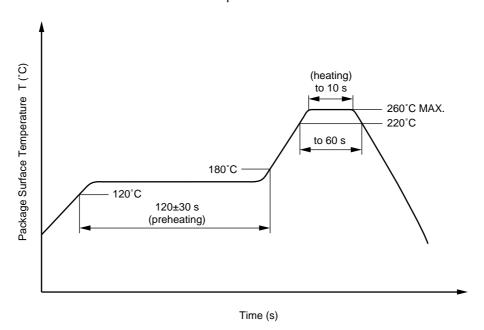
Time of peak reflow temperature
 Time of temperature higher than 220°C
 10 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

Peak temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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